Supplementary Information

Synergistic effect in bimetallic copper–silver (Cu_xAg) nanoparticles enhances silicon conversion in Rochow reaction

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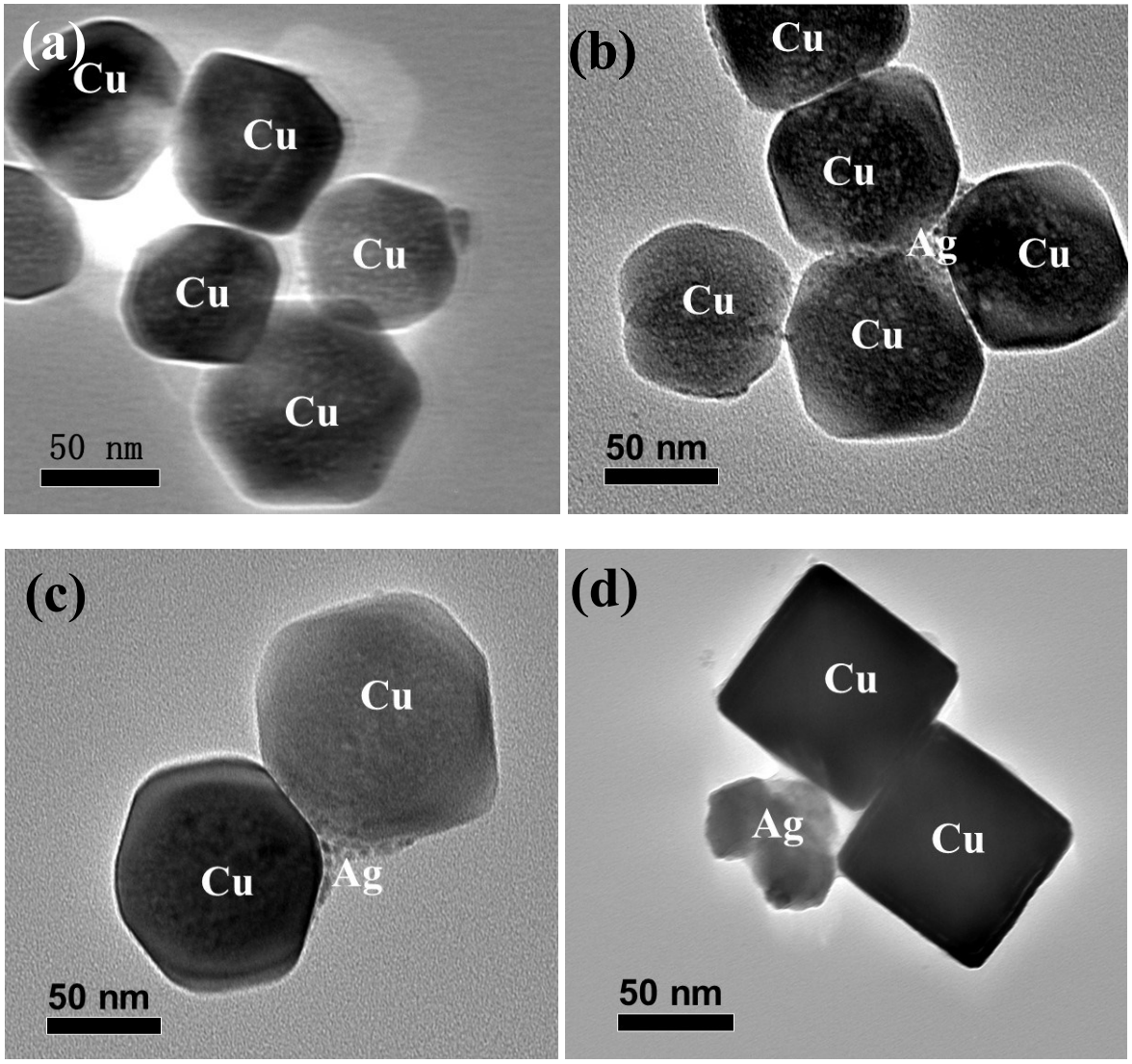

Fig. S1 TEM images of Cu_{50}-Ag (a), Cu_{20}-Ag (b), Cu_{10}-Ag (c), and Cu_5-Ag (d) nanoparticles.

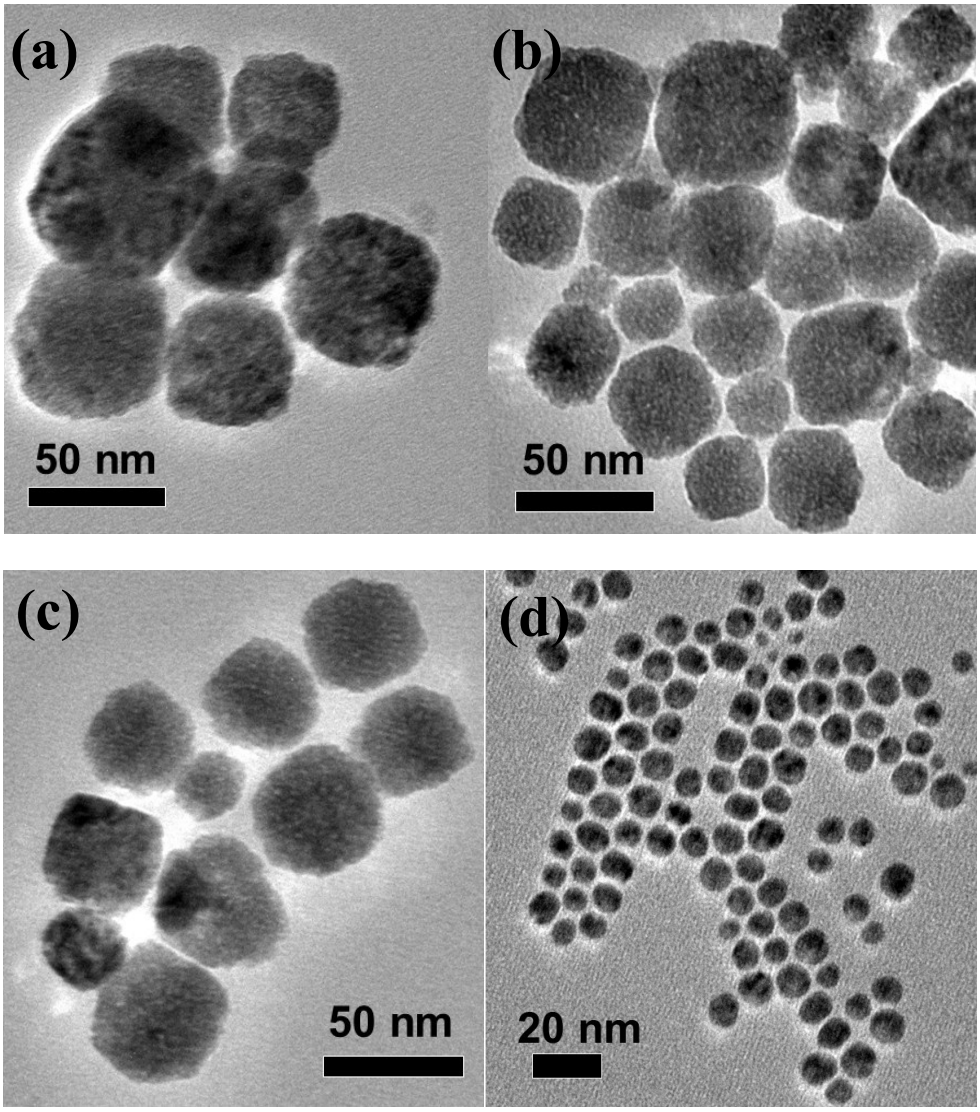

Fig. S2 TEM image of $Cu_{50}Ag$ (a), $Cu_{20}Ag$ (b), $Cu_{10}Ag$ (c), and $CuAg_2$ (d) bimetallic nanoparticles.

TEM image of Fig. S3 shows that CuAg nanoparticles have a mean size of 2.8 nm and a standard deviation of 1.9 after reaction for 1.5 h at 180 °C.

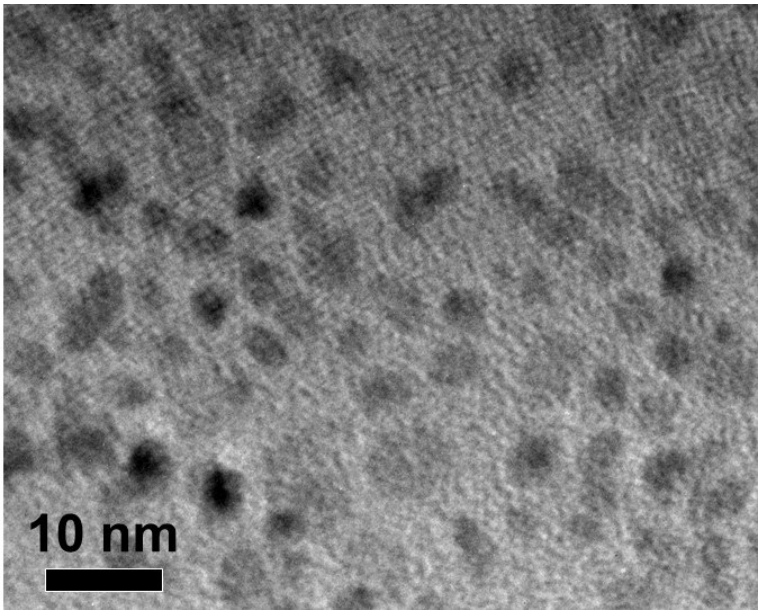

Fig. S3 TEM image of CuAg nanoparticles after reaction for 1.5 h at 180 °C.